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REVISIONS			
REV	DESCRIPTION	APPROVED	DATE
A	RELEASE		

- NOTES:
- UNLESS OTHERWISE SPECIFIED  
1. DIMENSIONS ARE IN INCHES (EXCEPT WHERE NOTED).  
MATERIAL: (USE CHECKED ITEMS FOR MATERIAL)
  - BOARD MATERIAL:  
( ) ISOLA 370HR OR EQUIVALENT  
( ) ISOLA-FR408HR OR EQUIVALENT  
( ) NELCO-4000-13  
( ) MEGTRON 6  
( ) ROGERS 4350B  
( ) ROGERS 4003C  
(X) OTHER ROGERS 4350B OUTER LAYER AND FR408HR INNER LAYER
  - THE PCB SHALL BE FABRICATED TO IPC-6012, TYPE X, CLASS 2.  
WORKMANSHIP SHALL CONFORM TO IPC-A-600, CLASS 2, CURRENT REVISIONS.
  - BOARD MATERIAL & CONSTRUCTION SHALL MEET THE REQUIREMENTS OF UL796  
WITH FLAMMABILITY RATING OF 94V-0.
  - OVERALL BOARD THICKNESS REFER TO LAMINATION DIAGRAM. TOLERANCE APPLIES  
AFTER ALL LAMINATION AND PLATING PROCESSES. IT IS TO BE MEASURED FROM  
TOP PCB METAL TO BOTTOM PCB METAL UNLESS OTHERWISE SPECIFIED.
  - BOW & TWIST NOT TO EXCEED 0.0075 IN. (0.75%) PER LINEAR INCH.  
BOW & TWIST SHOULD BE MEASURED PER IPC-TM-650, METHOD 2.4.22.

- TOOLING: (USE CHECKED ITEMS FOR TOOLING)
- PHOTO ETCH CIRCUITRY PER ENCLOSED GERBER R5274X OR ODB++ FORMAT FILE.  
DRILL LOCATION AND SIZE CONTROLLED BY EXCELLON CNC DRILL FILE.
  - IF STATED IN THE LAMINATION DIAGRAM, THE DIELECTRIC THICKNESS OF ANY  
CONTROLLED IMPEDANCE LAYER IS FOR REFERENCE ONLY. FINAL ACCEPTANCE  
SHALL BE DETERMINED BY THESE LAYERS HAVING A CHARACTERISTIC  
IMPEDANCE OF +/-10% OHMS AS STATED IN THE LAMINATION DIAGRAM. THE  
VENDOR CAN MAKE ADJUSTMENTS AS LONG AS THE STATED IMPEDANCE AND  
OVERALL BOARD THICKNESS IS MAINTAINED. ANY ADJUSTMENT MADE TO TRACE  
WIDTH OR SPACING MUST HAVE PRIOR WRITTEN APPROVAL FROM MAXIM.
  - ALL TRACES FILLETED OPTION TO ENHANCE RELIABILITY AT PAD JUNCTIONS  
WHERE SPACING PERMITS. UNLESS OTHERWISE SPECIFIED.  
( ) FILLETED  
(X) NOT FILLETED
  - LAYER TO LAYER REGISTRATIONS SHALL BE WITHIN .003 INCHES.  
LEGEND: +/- 0.007 INCHES

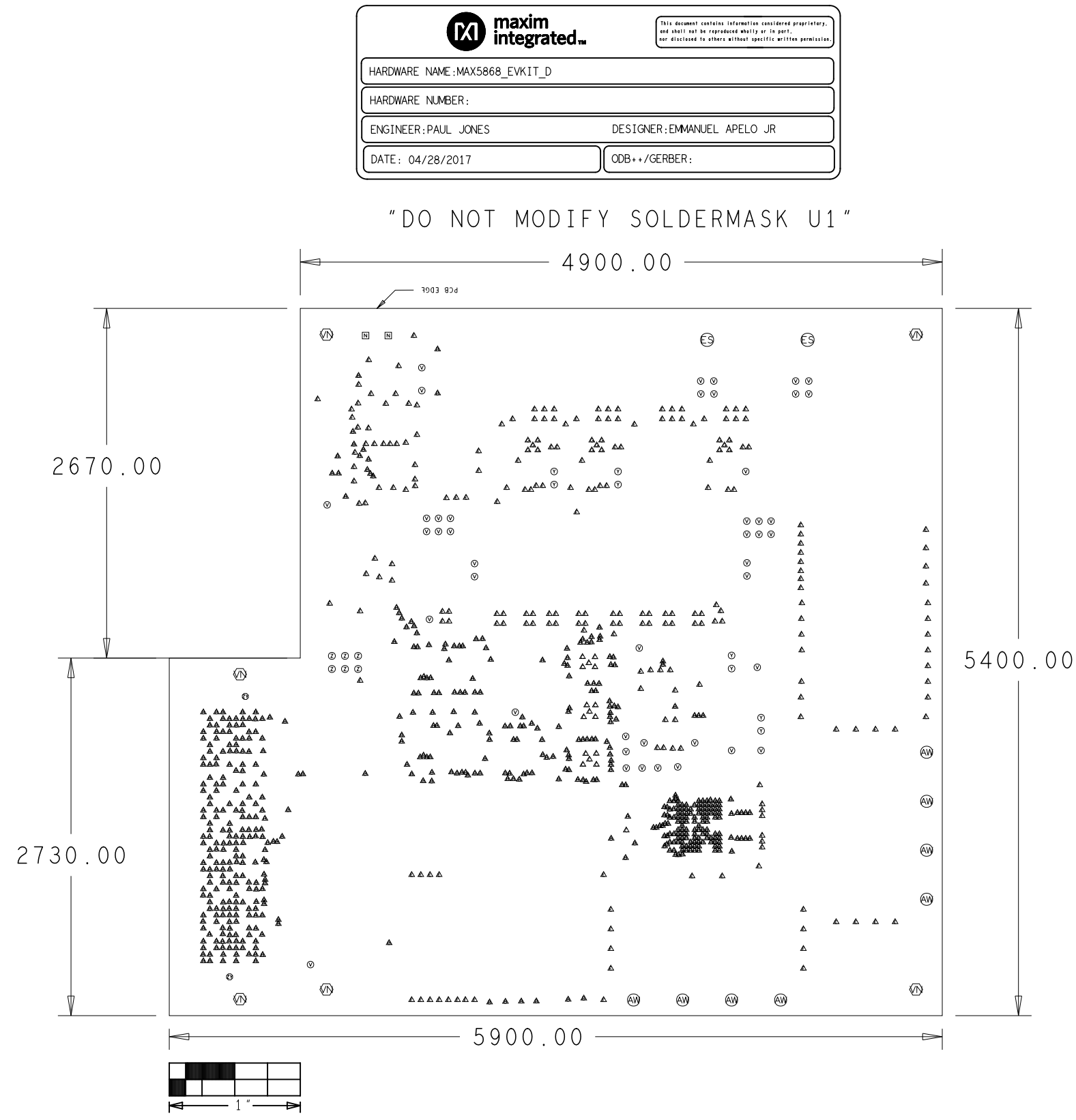
- FINISH: (USE CHECKED ITEMS FOR PLATING)
- FINISHED COPPER WEIGHT/THICKNESS:  
(X) REFER TO LAMINATION DIAGRAM FOR FINISHED COPPER WEIGHT/THICKNESS REQUIREMENTS.  
THE STARTING COPPER WEIGHT/THICKNESS CAN VARY AS LONG AS THE FINISHED COPPER  
WEIGHT/THICKNESS IS NOT LESS THAN THE SPECIFIED VALUE. UNLESS OTHERWISE SPECIFIED.  
( ) OTHER -----
  - CHECK ALL THAT APPLY  
( ) ELECTRODEPOSITED HARD GOLD PLATE, TYPE 1 (99.7% MIN GOLD), GRADE C  
(KNDOP HARDNESS 130-200), CLASS 1 (50-100 MICRO INCHES THICK) IN ACCORDANCE WITH MIL-G-45204C.  
GENERAL SURFACING REQUIREMENTS MUST MEET ANSI/IPC-A-600(CURRENT REV) SECTION 4.0,  
CLASS 3 (50-100 MICROINCHES THICK) OVER ELECTRODEPOSITED NICKEL PLATE  
IN ACCORDANCE WITH ANSI/IPC-A-600D, SECTION 4.0, CLASS 3 (200-600 MICROINCHES THICK).  
(X) FINISH CONDUCTOR SURFACES: IMMERSION GOLD, 3-8 MICRO INCHES OVER  
100 MICRO INCHES MINIMUM OF ELECTROLESS NICKEL.  
( ) FINISH CONDUCTOR SURFACES: IMMERSION GOLD, 2-5 MICRO INCHES OVER  
118-238 MICRO INCHES MINIMUM OF ELECTROLESS NICKEL.  
( ) FINGERS TO BE GOLD PLATED.  
( ) LEAD FREE AND RoHS COMPLIANT PLATING.  
( ) OTHER -----
  - DRILL SIZES ARE FINISHED HOLE SIZES. ALL HOLES SHALL BE LOCATED WITHIN .005 DTP.  
MINIMUM BARREL PLATING OF .001 IN. PLATED HOLES SHALL NOT BE ROUGH OR IRREGULAR  
SO AS TO HINDER PROPER SOLDER WICKING.
  - CHECK ALL THAT APPLY  
( ) GREEN SOLDERMASK OVER BARE COPPER/BARE GOLD (BOTH SIDES) WITH LIQUID PHOTO IMAGEABLE INK (LPI)  
PER ARTWORK.  
(X) GREEN TAIYO PSR-4000  
( ) OTHER -----
  - CHECK ALL THAT APPLY  
(X) APPLY SILKSCREEN USING A NON-CONDUCTIVE, WHITE EPOXY  
BASED INK PER ARTWORK.  
( ) OTHER -----
  - VENDOR LOGO & DATE CODE REQUIRED IN INK ON BOTTOM SIDE ONLY. DATE CODE FORMAT MUST BE YYYY MM ONLY  
TESTING:
  - FINAL ELECTRICAL TEST TO BE PERFORMED USING PROVIDED IPC-D-356A NETLIST OR ODB++ FORMAT FILE.  
(REQUIRED UNLESS OTHERWISE SPECIFIED IN QUOTE)  
THE PCB SHALL HAVE A VERIFICATION STAMP.
  - A TIME DOMAIN REFLECTOMETER REPORT FOR EACH IMPEDANCE CONTROLLED LAYER AND A CERTIFICATE  
OF COMPLIANCE SHALL BE PROVIDED BY VENDOR AT TIME OF SHIPMENT. INSTANCES WHERE TOR TESTING  
CAN'T BE PERFORMED BECAUSE THE TRACE LENGTH IS TOO SHORT ON THE OUTER LAYERS AT THE PIN ESCAPES  
IS ACCEPTABLE. ALL OTHER INSTANCES MUST BE REPORTED.
- MISCELLANEOUS:
- IF PRESENT, ALL BLIND/BURIED VIAS WITH AN ASPECT RATIO <1:1 TO BE PLATED SHUT WITH COPPER WHEN  
USED AS VIA-IN PAD OR AS A STACKED VIA. BLIND/BURIED VIAS WITH AN ASPECT RATIO >1:1 TO BE FILLED  
WITH NON-CONDUCTIVE EPOXY. UNLESS OTHERWISE SPECIFIED.
  - FOR ALL DRILL INFORMATION REFER TO DRILL CHART.  
( ) NON-CONDUCTIVE EPOXY. FILL AND CAP ALL 0.XXXX INCH DRILLED VIAS.  
( ) SILVER. FILL AND CAP ALL 0.XXXX INCH DRILLED VIAS.
  - FINISHED SURFACE CONTACTS AND FILLED VIAS TO BE FREE OF ANY PITS, SCRATCHES PROBE MARKS  
OR OTHER DEFORMITIES THAT COULD EFFECT THE APPEARANCE AND PERFORMANCE OF THE CONTACT  
SURFACE. CONTACTS ARE TO BE AS FLAT AS POSSIBLE. NOT TO EXCEED +/- 0.001" OF FLATNESS.
  - THIEVING:  
( ) SUPPLIER MAY ADD THIEVING TO COMPENSATE FOR LOW COPPER DENSITY AREAS ON THIS DESIGN.  
(X) SUPPLIER MAY NOT ADD THIEVING TO COMPENSATE FOR LOW COPPER DENSITY AREAS ON THIS DESIGN.
  - PENUT  
( ) PENUTS TO BE INSTALLED BY SUPPLIER.  
( ) PENUTS NOT TO BE INSTALLED BY SUPPLIER.  
(X) NOT APPLICABLE

IMPEDANCE TABLE				
LAYER	50 OHM	25 OHM	100 OHM TRACE / SPACE	50 OHM TRACE / SPACE
TOP	-	0.0240	0.0080/0.0055	0.0240/0.0160
L3_SIGNAL1	0.0075	-	0.0040/0.0040	-
L8_SIGNAL2	-	-	0.0040/0.0040	-
BOTTOM	-	-	0.0080/0.0055	-

NOTE: DO NOT EDIT THIS TABLE MANUALLY. USE IMPEDANCE TABLE GENERATOR FROM MAXIMTOOLS.

LAMINATION DIAGRAM				
LAYER NUMBER	LAYER NAME	COPPER THICKNESS (OZ./INCH)	DIELECTRIC THICKNESS (in.)	DIELECTRIC MATERIAL
1	TOP	1 OZ. 0.0014" MIN		FOIL
2	L2_GND	1 OZ. 0.0014"	0.0066	ROGERS-4350
3	L3_SIGNAL1	1 OZ. 0.0014"	0.008	ISOLA-FR408HR
4	L4_GND	1 OZ. 0.0014"	0.008	ISOLA-FR408HR
5	L5_POWER	1 OZ. 0.0014"	TBD	ISOLA-FR408HR
6	L6_GND	1 OZ. 0.0014"	0.008	ISOLA-FR408HR
7	L7_POWER	1 OZ. 0.0014"	0.008	ISOLA-FR408HR
8	L8_SIGNAL2	1 OZ. 0.0014"	0.008	ISOLA-FR408HR
9	L9_GND	1 OZ. 0.0014"	0.0066	ROGERS-4350
10	BOTTOM	1 OZ. 0.0014" MIN		FOIL
THE FINISHED PCB THICKNESS TO BE: 0.092" +/-0.010"				

DRILL CHART: TOP to BOTTOM					
ALL UNITS ARE IN MILS					
FIGURE	SIZE	TOLERANCE	PLATED	QTY	NOTES
△	8.0	+3.0/-6.0	PLATED	543	
△	10.0	+3.0/-8.0	PLATED	16	
△	18.0	+3.0/-16.0	PLATED	223	
△	20.0	+3.0/-18.0	PLATED	15	
⊙	39.37	+3.0/-3.0	PLATED	43	
⊙	43.31	+3.0/-3.0	PLATED	11	
⊙	45.28	+3.0/-3.0	PLATED	6	
⊙	84.65	+3.0/-3.0	PLATED	8	
⊙	125.0	+3.0/-3.0	PLATED	6	
⊙	250.0	+3.0/-3.0	PLATED	2	
[N]	35.43	+3.0/-3.0	NON-PLATED	2	
⊙	50.0	+3.0/-3.0	NON-PLATED	2	



TOLERANCES UNLESS OTHERWISE SPECIFIED		THE INFORMATION CONTAINED IN THIS DOCUMENT IS PROPRIETARY TO MAXIM. THE INFORMATION IN THIS DOCUMENT IS NOT TO BE SHOWN, REPRODUCED, OR DISCLOSED TO ANYONE OUTSIDE OF MAXIM WITHOUT PRIOR WRITTEN PERMISSION FROM MAXIM.		TITLE: FABRICATION DWG. MAX5868 EVKIT	
FRACTIONS	DECIMALS				
1/2-//	.XX +/- .01				
	.XXX +/- .005				
MATERIAL:		DRAWN BY: RM		DATE: 12/10/2016	
SEE NOTES		CHECKED BY:		DATE:	
FINISH:		APPR. BY:		DATE:	
SEE NOTES		APPR. BY:		DATE:	
		NOT TO SCALE		TEMPLATE REV 1.0	
				SHEET 1 OF 1	